1	High-Speed High-Precision High-End Printer YSP	Model YSP (Model : KHT-000)		
ļ		Applicable PCB (mm) L50 x W50 to L510 x W460 * Applicable for printing L600		
		Printing line-tact	11.0sec (Normal printing) (Optimum conditions) * Optimum conditions : L180 x W130mm PCB size, Squeezee speed 100mm/sec, etc.	
		Accuracy	Printing accuracy (3o) : +/- 0.025mm Positioning repeatability (3o) : +/- 0.005mm	
		Applicable stencil size (mm)	L600 x W550, L550 x W650           L1,640 x W1,640 x H1,400 (Normal conveyor)           L1,973 x W1,640 x H1,400 (Exit extension conveyor)	
		External dimension (mm)		
	<ul> <li>★3S head (3S : Swing Single Squeegee)</li> <li>★PSC System (Print Stability Control)</li> </ul>	Mainht		
		Weight	Approx. 1,500kg	
	Compact Super-High-Speed Modular YS24 YS24X	Model	YS24 (Model : KKE-000/100/200)	YS24X (Model : KKT-000/100/200)
		Applicable PCB (mm)	L50 x W50 to L700 x W460	L50 x W50 to L700 x W460
		Mounting capability (optimum)	72k CPH -50k CPH (IPC 9850)	54k CPH - 30k CPH (IPC 9850)
		Mounting accuracy	Absolute accuracy ( $\mu$ +3 $\sigma$ ) : +/- 0.05mm/CHIP(QFP) Repeatability (3 $\sigma$ ) : +/- 0.03mm/CHIP(QFP)	Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP) Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)
		Applicable components	0402(Metric base) to 32 x 32mm, Max Height 6.5mm	0402(Metric base) to 45 x 45mm, Max Height 15mm, Ball type electrodes applicable
		Number of component types	Tape reel : 120 types (Fixed plates, Max., 8mm width) Tape reel : 96 types (FES Carts, Max., 8mm width)	Tape reel : 96 types (Max., 8mm width) 62 types when sATS installed Tray : 30 types (When sATSII installed)
İ		External dimension (mm)	L1,254 x W1,687 x H1,445	L1,254 x W1,687 x H1,445
	★Side-view recognition		L1,544 x W2,183 x H1,445 (Extension conveyor, FES Carts)	L1,544 x W2,020 x H1,545 (Extension conveyor, when sATSII installed)
	★sATSII applicable	Weight	Approx. 1,700kg	Approx. 1,700kg (Main unit only), Approx. 1,890kg (When sATSII installed)
ľ	Compact Link Speed Meduler	Model	YS12 (Model : KHY-000)	YS12F (Model : KKJ-100)
	Compact High-Speed Modular YS12 YS12F	Applicable PCB (mm)	L50 x W50 to L640 x W460	L50 x W50 to L640 x W460 (W360 when ATS15 installed)
		Mounting capability	36k CPH -24k CPH (IPC 9850)	20kCPH - 14k CPH (IPC 9850)
		Mounting accuracy	Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)	Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP) Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)
		A		
		Applicable components	0402(Metric base) to 32 x 32mm, Max Height 6.5mm	0402(Metric base) to 45 x 100mm, Max Height 15mm, Ball type electrodes applical
		Number of component types	Tape reel : 120 types (Fixed plates, Max., 8mm width) Tape reel : 96 types (FES Carts, Max., 8mm width)	Tape reel : 108 types (Max., 8mm width) Tape reel : 47 types and Tray : 15 types (When ATS15 installed)
	★When LED Package is installed,	External dimension (mm)	L1,254 x W1,440 x H1,445	L1,254 x W1,440 x H1,445 (Main unit only) L1,254 x W1,755 x H1,470 (When ATS15 installed)
l	Max. L1,200 is applicable	Weight	Approx. 1,250kg	Approx. 1,250kg (Main unit only), Approx. 1,370kg (When ATS15 is installed)
	High Speed Coneral purpose Medular	Model	YS100 (Model : KJJ-000)	
I	High-Speed General-purpose Modular	Applicable PCB (mm)	L50 x W50 to L700 x W460 (W410 When sATS installed)	
		Mounting capability	25k CPH - 17k CPH (IPC 9850) (14,1k CPH IPC 9850 When 12mm feeder pitch interface installed)	
		Mounting accuracy	Absolute accuracy (µ+3σ) : +/- 0.05mm/CHIP(QFP)	
			Repeatability (3o) : +/- 0.03mm/CHIP(QFP)	
		Applicable components	0402(Metric base) to 45x 100mm, Max Height 15mm, Ball type electrodes applicable	
		Number of component types	Tape reel : 96 / 126 types (Max., 8mm width), 72 / 87 types (When sATS installed) with 16 / 12mm pitch interface Tray : 30 types (When sATS installed), 60 types (When dYTF installed) Max., JEDEC	
		External dimension (mm)	L1,655 x W1,562 x H1,445 L1,655 x W1,562 x H1,445 L1,655 x W1,904 x H1,545 (When sATS installed) L2,859 x W1,689 x H1,445 (When dYTF installed)	
		Weight	Approx. 1,650kg (Main unit only), Approx. 150kg (sATS only), Approx. 450kg (dYTF only)	
		Model	Approx. 1,000kg (wall unit unit), Approx. 100kg (SA13 Unity), Approx. 400kg (UT 11 Unity) <b>YS88</b> (Model : KJH-000)	
$\left  \right $	Multi-Functional Wide-Range Modular	WOUCI		
	Multi-Functional Wide-Range Modular	Applicable BCB (mm)	LE0 x WE0 to L700 x W/460 (W/410 when cATC installed)	
	Multi-Functional Wide-Range Modular	Applicable PCB (mm)	L50 x W50 to L700 x W460 (W410 when sATS installed)	
	Multi-Functional Wide-Range Modular	Applicable PCB (mm) Mounting capability Mounting accuracy	8.4k CPH - 7.9k CPH (IPC 9850) Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)	
	Multi-Functional Wide-Range Modular	Mounting capability Mounting accuracy	8.4k CPH - 7.9k CPH (IPC 9850) Absolute accuracy (µ+3σ) : +/- 0.05mm/CHIP(QFP) Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)	
	Multi-Functional Wide-Range Modular	Mounting capability	8.4k CPH - 7.9k CPH (IPC 9850)           Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes applied to the second secon	
	Multi-Functional Wide-Range Modular	Mounting capability Mounting accuracy	8.4k CPH - 7.9k CPH (IPC 9850) Absolute accuracy (µ+3σ) : +/- 0.05mm/CHIP(QFP) Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)	ad) with 16 / 12mm pitch interface
	Multi-Functional Wide-Range Modular	Mounting capability Mounting accuracy Applicable components	8.4k CPH - 7.9k CPH (IPC 9850) Absolute accuracy (µ+30) : +/- 0.05mm/CHIP(QFP) Repeatability (30) : +/- 0.03mm/CHIP(QFP) 0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes ay Tape reel : 90 / 119 types (Max., 8mm width), 67 / 81 types (When sATS install	ed) with 16 / 12mm pitch interface EDEC
	Multi-Functional Wide-Range Modular         YS888         Image: State of the	Mounting capability Mounting accuracy Applicable components Number of component types	8.4k CPH - 7.9k CPH (IPC 9850)         Absolute accuracy (µ+30) : +/- 0.05mm/CHIP(QFP)         Repeatability (30) : +/- 0.03mm/CHIP(QFP)         0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes ap         Tape reel : 90 / 119 types (Max., 8mm width), 67 / 81 types (When sATS install         Tray : 30 types (When sATS installed), 60 types (When dYTF installed) Max., J         L1,655 x W1,562 x H1,445	o) with 16 / 12mm pitch interface EDEC When dYTF installed)
	YS88	Mounting capability Mounting accuracy Applicable components Number of component types External dimension (mm)	8.4k CPH - 7.9k CPH (IPC 9850)         Absolute accuracy (µ+30) : +/- 0.05mm/CHIP(QFP)         Repeatability (30) : +/- 0.03mm/CHIP(QFP)         0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes ap         Tape reel : 90 / 119 types (Max., 8mm width), 67 / 81 types (When sATS install         Tray : 30 types (When sATS installed), 60 types (When dYTF installed) Max., J         L1,655 x W1,562 x H1,445         L1,655 x W1,904 x H1,545 (When sATS installed) L2,859 x W1,689 x H1,445 (	o) with 16 / 12mm pitch interface EDEC When dYTF installed)
	YS88 with the second s	Mounting capability Mounting accuracy Applicable components Number of component types External dimension (mm) Weight	8.4k CPH - 7.9k CPH (IPC 9850)           Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes a           Tape reel : 90 / 119 types (Max., 8mm width), 67 / 81 types (When sATS install           Tray : 30 types (When sATS installed), 60 types (When dYTF installed) Max., 3           L1,655 x W1,562 x H1,445           L1,655 x W1,562 x H1,445           L1,655 x W1,562 x H1,445           Approx. 1,650kg (Main unit only), Approx. 150kg (sATS only), Approx. 450kg (d	d) with 16 / 12mm pitch interface EDEC When dYTF installed) YTF only)
	YS88 with the second s	Mounting capability Mounting accuracy Applicable components Number of component types External dimension (mm) Weight Model	8.4k CPH - 7.9k CPH (IPC 9850)           Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes and Tape reel : 90 / 119 types (Max., 8mm width), 67 / 81 types (When sATS installed)           Tray : 30 types (When sATS installed), 60 types (When dYTF installed) Max., J           L1,655 x W1,562 x H1,445           L1,655 x W1,562 x H1,445           Approx. 1,650kg (Main unit only), Approx. 150kg (sATS only), Approx. 450kg (d)           YSI-12 (In-line)           L50 x W50 to L620 x W460 (Optical inspection area)	d) with 16 / 12mm pitch interface EDEC When dYTF installed) YTF only) <b>YSI-S</b> (Off-line) L50 x W50 to L510 x W460 (Optical inspection area)
	YS88 time	Mounting capability Mounting accuracy Applicable components Number of component types External dimension (mm) Weight Model Applicable PCB (mm)	8.4k CPH - 7.9k CPH (IPC 9850)           Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes agent is the strain strain strain is the strain	a) with 16 / 12mm pitch interface         EDEC         When dYTF installed)         YTF only) <b>YSI-S</b> (Off-line)         L50 x W50 to L510 x W460 (Optical inspection area)         Max L650 applicable         25 sec for L330 x W250 PCB (29.5msec/cm² or 3.390mm²/sec)         'In case of resolution 19µm (44.6 x 37.4mm/view, 0.42sec/view)         Visible RGB / Intra-Red : 19µm / 10µm (Factory build options)
	YS88 time	Mounting capability Mounting accuracy Applicable components Number of component types External dimension (mm) Weight Model Applicable PCB (mm) Inspection speed Resolution	8.4k CPH - 7.9k CPH (IPC 9850)           Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes and types (When sATS installed)           1ape reel : 90 / 119 types (Max., 8mm width), 67 / 81 types (When sATS installed)           1ray : 30 types (When sATS installed), 60 types (When dYTF installed) Max., J           1.655 x W1.962 x H1,445           1.655 x W1.904 x H1,545 (When sATS installed) 12,859 x W1,689 x H1,445 (           Approx. 1.650kg (Main unit only), Approx. 150kg (sATS only), Approx. 450kg (d           YSi-12 (In-line)           L50 x W50 to L620 x W460 (Optical inspection area)           Max 1.000 applicable.           15 sec for L300 x W250 PCB (18mse/cm² of 5,555mm²/sec)           1n case of resolution 19µm (44.6 x 37.4mm/iew, 0.32sec/iew)           Visible RGB / Intra-Red : 19µm / 10µm / 5µm / 0.7µm (Factory build options)           Laser Height: 5µm	d) with 16 / 12mm pitch interface EDEC When dYTF installed) YTF only) <b>YSI-S</b> (Olf-line) L50 x W50 to L510 x W460 (Optical inspection area) Max L650 applicable 25 sec for L330 x W250 PCB (29.5msec/cm² or 3,390mm²/sec) "In case of resolution 19µm (44.6 x 37.4mm/view, 0.42sec/view) Visible RGB / Intra-Red : 19µm / 10µm (Factory build options) Laser Height: 5µm
	YS88 with the second s	Mounting capability Mounting accuracy Applicable components Number of component types External dimension (mm) Weight Model Applicable PCB (mm) Inspection speed Resolution Target items	8.4k CPH - 7.9k CPH (IPC 9850)           Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes and types (When sATS installed)           Tray : 30 types (When sATS installed), 60 types (When dYTF installed) Max., J           L1,655 x W1,562 x H1,445           L1,655 x W1,562 x H1,445           L1,655 x W1,904 x H1,545 (When sATS installed) L2,859 x W1,689 x H1,445 (           Approx. 1,650kg (Main unit only), Approx. 150kg (sATS only), Approx. 450kg (d           YSI-12 (In-line)           L60 x W50 to L620 x W460 (Optical inspection area)           Max L1,000 applicable.           15 sec for L330 x W250 PCB (18msec/cm² of 5,555mm²/sec)           'In case of resolution 19µm (44.6 x 37.4mm/view, 0.32sec/view)           Visible RGB / Intra-Red : 19µm / 10µm / 5µm / 0.7µm (Factory build options)           Laser Height: 5µm           Post Printing, Post Mounting, Post Reflow	d) with 16 / 12mm pitch interface EDEC When dYTF installed) YTF only) <b>YSI-S</b> (Off-line) L50 x W50 to L51 0 x W460 (Optical inspection area) Max L650 applicable 25 sec for L330 x W250 PCB (29.5msec/cm² or 3,390mm²/sec) 1in case of resolution 19µm (44.6 x 37.4mm\view, 0.42sec/view) Visible RGB / Intra-Red : 19µm / 10µm (Factory build options) Laser Height: 5µm Post reflow
	YS88 with the second s	Mounting capability Mounting accuracy Applicable components Number of component types External dimension (mm) Weight Model Applicable PCB (mm) Inspection speed Resolution Target items Camera	8.4k CPH - 7.9k CPH (IPC 9850)           Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes and types (When SATS installed), 60 types (When ATS installed) Max., J           Tray : 30 types (When SATS installed), 60 types (When ATS installed) Max., J           L1.655 x W1.562 x H1.445           L1.655 x W1.964 x H1.545 (When sATS installed) L2.859 x W1.689 x H1.445 (           Approx. 1.650kg (Main unit only), Approx. 150kg (SATS only), Approx. 450kg (d           YSI-12 (In-line)           L50 x W50 to L520 x W460 (Optical inspection area)           Max L1.000 applicable.           15 sec for L330 x W250 PCB (18msec/cm <sup>2</sup> or 5,555mm <sup>2</sup> /sec)           "in case of resolution 19µm (44.6 x 37.4mm/view, 0.32sec/view)           Visible R6B/ Intra-Red : 19µm / 10µm / 5µm / 0.7µm (Factory build options)           Laser Height: 5µm           Post Printing, Post Mounting, Post Reflow           5M pixel color CCD	d) with 16 / 12mm pitch interface EDEC When dYTF installed) YTF only) YTF Solly L50 x W50 to L510 x W460 (Optical inspection area) Max L650 applicable 25 sec for L330 x W250 PCB (29.5msec/cm² or 3.390mm²/sec) 'In case of resolution 19µm (44.6 x 37.4mm²/sec, 0.42sec/view) Visible RGB /Intra-Red : 19µm / 10µm (Factory build options) Laser Height: 5µm Post reflow 5M pixel color CCD
	YS88 with the second s	Mounting capability Mounting accuracy Applicable components Number of component types External dimension (mm) Weight Model Applicable PCB (mm) Inspection speed Resolution Target items	8.4k CPH - 7.9k CPH (IPC 9850)           Absolute accuracy (μ+3σ) : +/- 0.05mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           Repeatability (3σ) : +/- 0.03mm/CHIP(QFP)           0402(Metric base) to 55x 100mm, Max Height 25.5mm, Ball type electrodes and types (When sATS installed)           Tray : 30 types (When sATS installed), 60 types (When dYTF installed) Max., J           L1,655 x W1,562 x H1,445           L1,655 x W1,562 x H1,445           L1,655 x W1,904 x H1,545 (When sATS installed) L2,859 x W1,689 x H1,445 (           Approx. 1,650kg (Main unit only), Approx. 150kg (sATS only), Approx. 450kg (d           YSI-12 (In-line)           L60 x W50 to L620 x W460 (Optical inspection area)           Max L1,000 applicable.           15 sec for L330 x W250 PCB (18msec/cm² of 5,555mm²/sec)           'In case of resolution 19µm (44.6 x 37.4mm/view, 0.32sec/view)           Visible RGB / Intra-Red : 19µm / 10µm / 5µm / 0.7µm (Factory build options)           Laser Height: 5µm           Post Printing, Post Mounting, Post Reflow	d) with 16 / 12mm pitch interface EDEC When dYTF installed) YTF only) <b>YSI-S</b> (Off-line) L50 x W50 to L510 x W460 (Optical inspection area) Max L650 applicable 25 sec for L330 x W250 PCB (29.5msec/cm² or 3,390mm²/sec) 11n case of resolution 19µm (44.6 x 37.4mm/view, 0.42sec/view) Visible RGB / Intra-Red : 19µm / 10µm (Factory build options) Laser Height: 5µm Post reflow









\* All AOI Power supply is [Single-Phase AC 200/208/220/230V +/-10% 50/60Hz]

\* All Mounter machines Air supply source is [0.45MPA], AOI machines [0.4MPA or more, in clean, dry state] (Only when marker unit installed)







Hansemannstrasse 12, 41468 Neuss, Germany Tel: +49(0) 2131 2013 520 Email: info-yime@yamaha-motor.de URL http://www.yamaha-motor-im.eu YIMA: Yamaha Motor IM America Inc. 1270 Chastain Road, Kennesaw, Georgia 30144 USA Tel: 1-770-420-5825 URL http://www.yamaha-motor-im.com PCB ASSEMBLY SYSTEM

# JUST FIT SOLUTION No.1

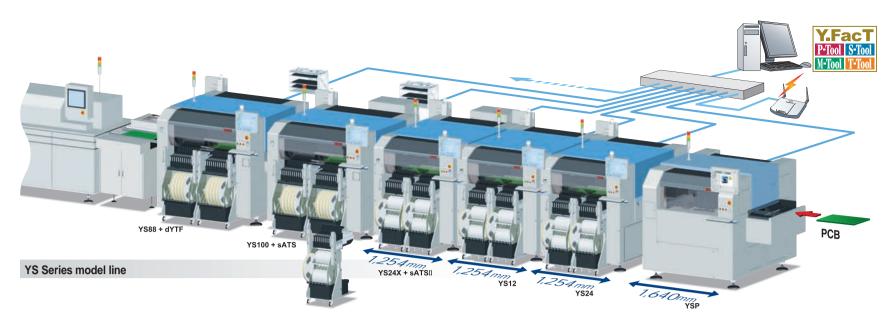




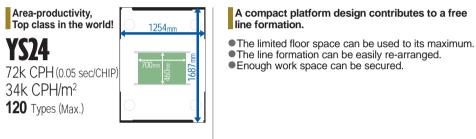
Quick and accurate position control by servo-motor drive. By control of variable speed and changeable interval, the components feeding achieves wide flexibility and high-speed stable supply. Excellent setup handling by single lane design

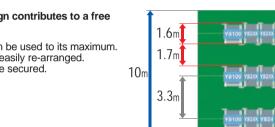
Effective intelligent functions by micro-computer. ID verification, LED indicator, Splicing-sensor application, maintenance history, ...etc.

For tape reels from 4mm to 88mm width, made for each tape widths & small strips. Low maintenace cost.

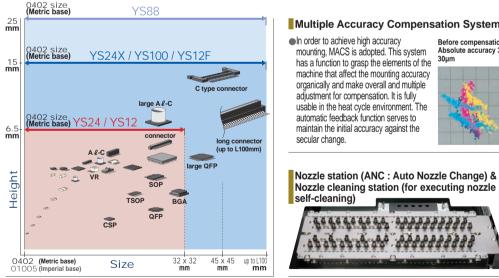


### **Superb Area-Productivity** Value



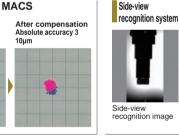


#### 3 Wide flexibility & Excellent mounting quality Value



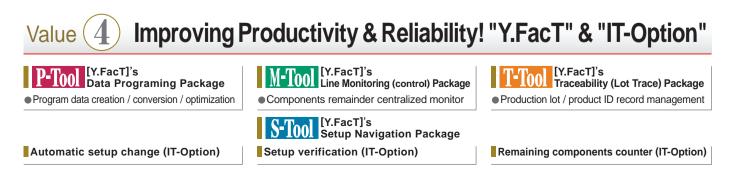
Multiple Accuracy Compensation System : MACS

In order to achieve high accuracy mounting, MACS is adopted. This system ute accuracy 3 30µm has a function to grasp the elements of the machine that affect the mounting accuracy organically and make overall and multiple adjustment for compensation. It is fully usable in the heat cycle environment. The automatic feedback function serves to maintain the initial accuracy against the secular change

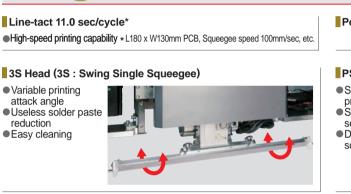


Multi-camera & Side light





#### 5 High-speed! Excellent printing! the YSP printer Value











**Cooperation with YSi AOI** Value

One click conversion / creation, AOI program data **QA** Option

True close loop inspection process





Positioning repeatability (3) ±0.005mm

PSC : Print Stability Control

 Stability of printing quality Shortening of setup time Decrease of loss solder paste





## **Quick! Easy! No-mistake! Operation & Setup**



#### 8 **Customizing Flexibility** Value

PoP / SIP\* application <sup>3</sup> •Flux dipping / transfer stamping application Special carrier application Shield-case application Solder-tape cutting and mounting application

Package on Package / System in Package

